

2.0A SURFACE MOUNT SCHOTTKY BARRIER RECTIFIER

PowerDI[®]123

DFLS240

Features

- Guard Ring Die Construction for Transient Protection
- High Current Capability
- Low Leakage Current
- Patented Interlocking Clip Design for High Surge Current Capacity
- Lead Free Finish, RoHS Compliant (Note 4)
- "Green" Molding Compound (No Br, Sb)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: PowerDl[®]123
- Case Material: Molded Plastic, "Green" Molding Compound UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminal Connections: Cathode Band
- Terminals: Finish Matte Tin Annealed Over Copper leadframe. Solderable per MIL-STD-202, Method 208 ³
- Marking Information: See Page 2
- Ordering Information: See Page 2
- Weight: 0.01 grams (approximate)



Top View

Maximum Ratings @T_A = 25°C unless otherwise specified

| Characteristic | Symbol | Value | Unit |
|---|--|-------|------|
| Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage | V _{RRM} V _{RWM} V _R | 40 | V |
| RMS Reverse Voltage | V _{R(RMS)} | 28 | V |
| Average Forward Current | I _{F(AV)} | 2.0 | А |
| Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load | I _{FSM} | 40 | А |

Thermal Characteristics

| Characteristic | Symbol | Тур | Мах | Unit |
|--|------------------|--------|--------|------|
| Thermal Resistance, Junction to Ambient Air (Note 1) | $R_{\theta JA}$ | 73 | _ | °C/W |
| Thermal Resistance, Junction to Soldering Point (Note 2) | $R_{\theta JS}$ | — | 13 | °C/W |
| Operating Temperature Range | TJ | -65 to | °C | |
| Storage Temperature Range | T _{STG} | -65 to |) +150 | °C |

Electrical Characteristics @T_A = 25°C unless otherwise specified

| Characteristic | Symbol | Min | Тур | Max | Unit | Test Condition |
|------------------------------------|--------------------|-----|------|------|------|---------------------------------|
| Reverse Breakdown Voltage (Note 3) | V _{(BR)R} | 40 | | | V | I _R = 20μA |
| Forward Voltage | VF | _ | 0.52 | 0.58 | V | I _F = 1.0A |
| r orward voltage | | | 0.65 | 0.7 | v | I _F = 2.0A |
| Leakage Current (Note 3) | I _R | _ | | 20 | | $V_R = 40V, T_A = 25^{\circ}C$ |
| | | | | 6.0 | mA | $V_R = 40V, T_A = 100^{\circ}C$ |
| Total Capacitance | CT | _ | 28 | | рF | $V_{R} = 10V, f = 1.0MHz$ |

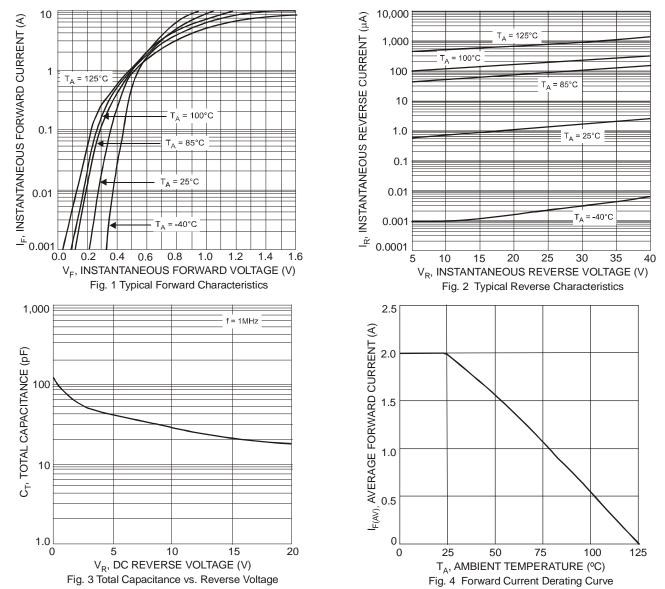
Notes: 1. Part mounted on Polymide board with 2 oz., copper, 74 mm^2 pad layout. $T_A = 25^{\circ}\text{C}$

2. Theoretical R_{BJS} calculated from the top center of the die straight down to the PCB/cathode tab solder junction.

3. Short duration pulse test used to minimize self-heating effect.

4. EU Directive 2002/95/EC (RoHS). All applicable RoHS exemptions applied, see EU Directive 2002/95/EC Annex Notes.



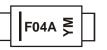


Ordering Information (Note 5)

| Part Number | Case | Packaging |
|-------------|--------------------------|------------------|
| DFLS240-7 | PowerDI [®] 123 | 3000/Tape & Reel |

Notes: 5. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

Marking Information



F04A = Product Type Marking Code YM = Date Code Marking Y = Year (ex: R = 2004) M = Month (ex: 9 = September)

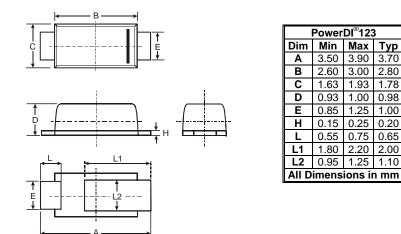
| Date Code Key | | | | | | | | | | | | |
|---------------|------|------|-----|-----|------|------|------|------|-----|-----|------|------|
| Year | 2003 | 2004 | 20 | 005 | 2006 | 2007 | 2008 | 2009 | 20 | 010 | 2011 | 2012 |
| Code | Р | R | | S | Т | U | V | W | | Х | Y | Z |
| Month | Jan | Feb | Mar | Apr | May | Jun | Jul | Aug | Sep | Oct | Nov | Dec |
| Code | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | 0 | Ν | D |

PowerDI is a registered trademark of Diodes Incorporated.

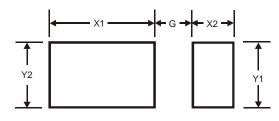
DFLS240



Package Outline Dimensions



Suggested Pad Layout



| Dimensions | Value (in mm) |
|------------|---------------|
| G | 1.0 |
| X1 | 2.2 |
| X2 | 0.9 |
| Y1 | 1.4 |
| Y2 | 1.4 |

3.70 2.80

1.78

0.98

1.00

0.20

0.65

2.00

1.10

IMPORTANT NOTICE

Diodes Incorporated and its subsidiaries reserve the right to make modifications, enhancements, improvements, corrections or other changes without further notice to any product herein. Diodes Incorporated does not assume any liability arising out of the application or use of any product described herein; neither does it convey any license under its patent rights, nor the rights of others. The user of products in such applications shall assume all risks of such use and will agree to hold Diodes Incorporated and all the companies whose products are represented on our website, harmless against all damages.

LIFE SUPPORT

Diodes Incorporated products are not authorized for use as critical components in life support devices or systems without the expressed written approval of the President of Diodes Incorporated.

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Diodes Incorporated: